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SEMICONDUCTOR®

November 2013

FQB11N40C N-Channel QFET[®] MOSFET 400 V, 10.5 A, 530 mΩ

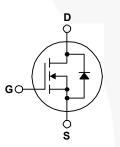
Description

These N-Channel enhancement mode power field effect transistors are produced using Fairchild's proprietary, planar stripe, DMOS technology. This advanced technology has been especially tailored to minimize onstate resistance, provide superior switching performance, and withstand high energy pulse in the avalanche and commutation mode. These devices are well suited for high efficiency switched mode power supplies, active power factor correction, electronic lamp ballasts based on half bridge topology.

Features

- + 10.5 A, 400V, ${\rm R}_{\rm DS(on)}$ = 530 m Ω (Max.) @ V_{\rm GS} = 10 V, ${\rm I}_{\rm D}$ = 5.25 A
- Low Gate Charge (Typ. 28 nC)
- Low Crss (Typ. 85 pF)
- 100% Avalanche Tested





Absolute Maximum Ratings T_c = 25°C unless otherwise noted.

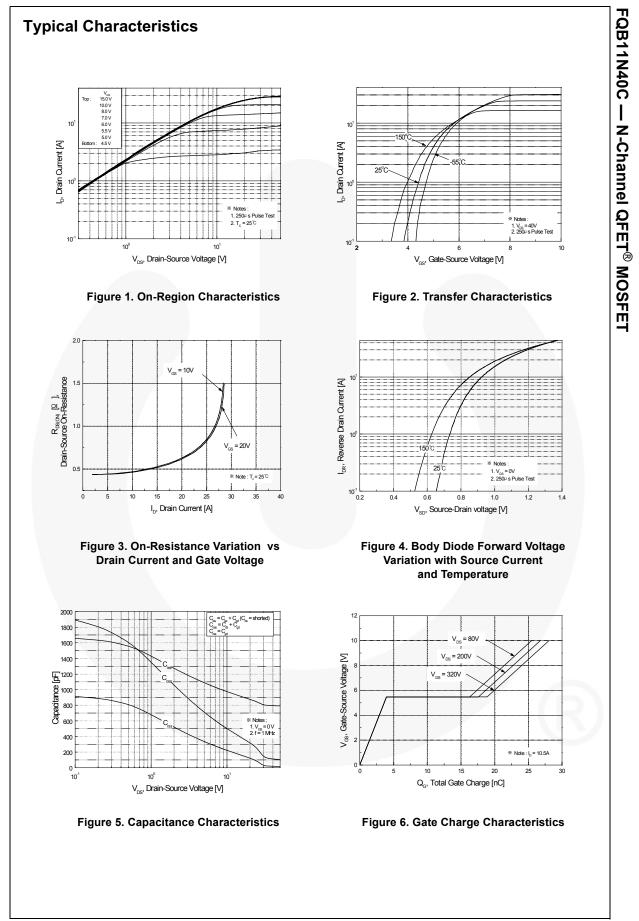
Symbol	Parameter		FQB11N40CTM	Unit
V _{DSS}	Drain-Source Voltage		400	V
I _D	Drain Current - Continuous ($T_C = 25^{\circ}C$)		10.5	А
	- Continuous (T _C = 100°C)		6.6	A
DМ	Drain Current - Pulsed	Note 1)	42	A
V _{GSS}	Gate-Source Voltage		± 30	V
E _{AS}	Single Pulsed Avalanche Energy (Note 2)		360	mJ
I _{AR}	Avalanche Current (N		11	A
E _{AR}	Repetitive Avalanche Energy (Note 1)		13.5	mJ
dv/dt	Peak Diode Recovery dv/dt (Note 3)		4.5	V/ns
PD	Power Dissipation ($T_C = 25^{\circ}C$)		135	W
	- Derate above 25°C		1.07	W/°C
T _J , T _{STG}	Operating and Storage Temperature Range		-55 to +150	°C
TL	Maximum Lead Temperature for Soldering, 1/8" from Case for 5 Seconds		300	°C

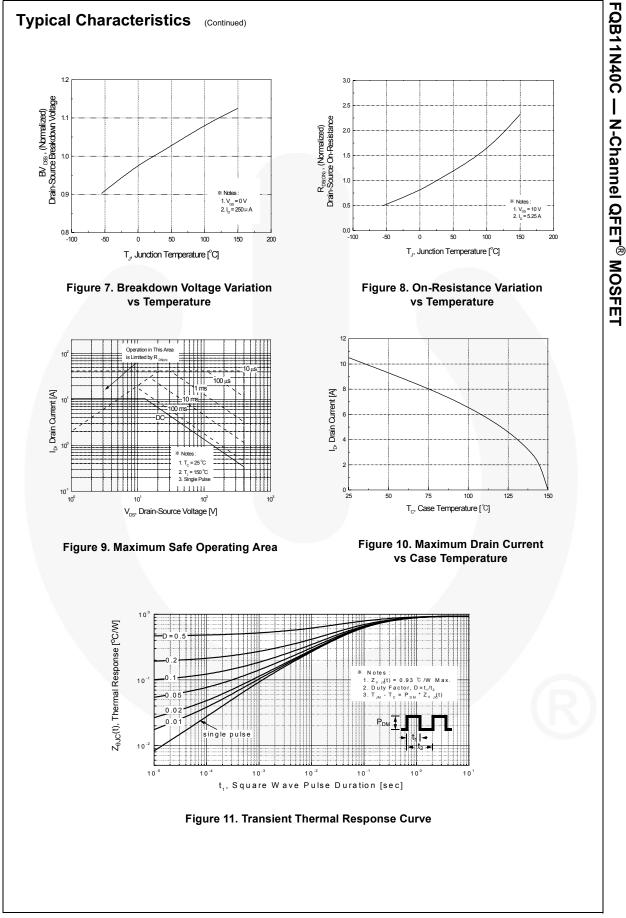
Thermal Characteristics

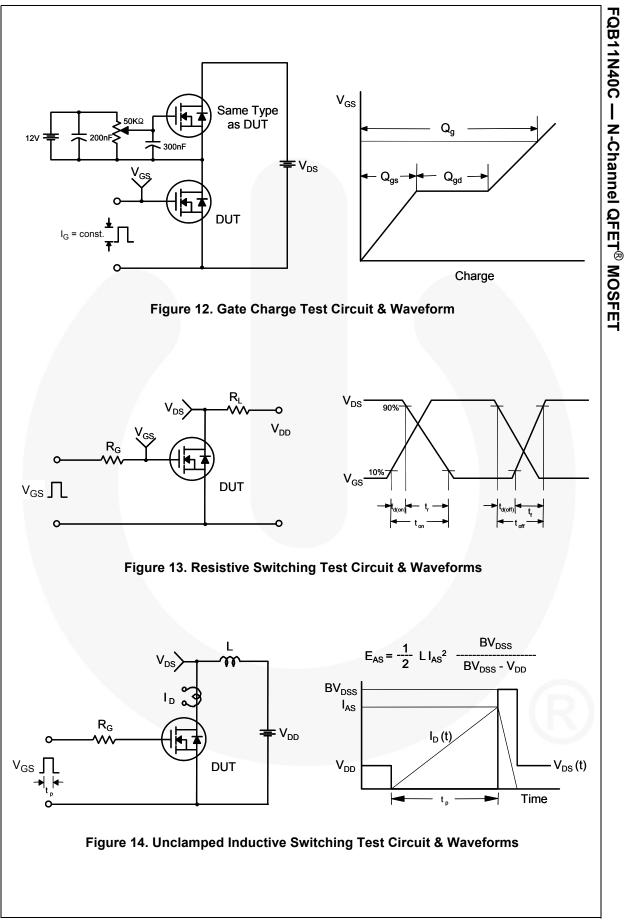
Symbol	Parameter	FQB11N40CTM	Unit	
$R_{ ext{ heta}JC}$	Thermal Resistance, Junction to Case, Max.	0.93		
D	Thermal Resistance, Junction to Ambient (minimum pad of 2 oz copper), Max.	62.5	°C/W	
R_{\thetaJA}	Thermal Resistance, Junction to Ambient (*1 in ² pad of 2 oz copper), Max.	40		

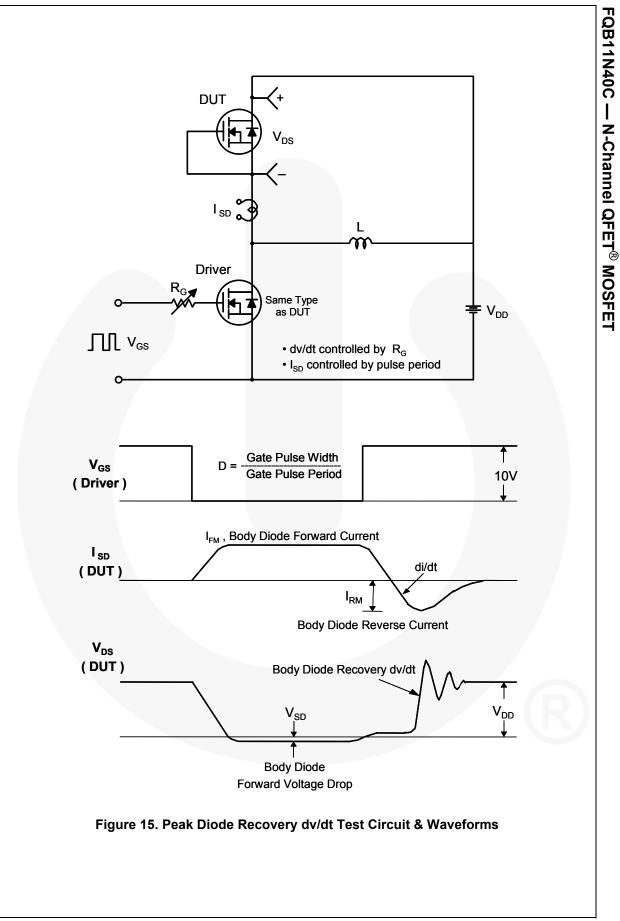
Part Number FQB11N40CTM		-				Reel S	Size	Tape Width 24 mm		Quantity 800 units	
						330 r	nm				
lectric	cal Cha	aracteristics	Γ _c = 25°C unl	less otherwis	se noted.						
Symbol		Parameter			Test Con	ditions		Min	Тур	Max	Unit
	rootorio	tion									
BV _{DSS}	Drain So		200	$V_{\alpha\alpha} = 0$	$1 \sqrt{l_{p}} = 25$	ο Δ		400			V
ABV _{DSS}			V_{GS} = 0 V, I _D = 250 µA			400			v		
ΔT_{J}	Breakdown Voltage Temperature Coefficient		I_D = 250 µA, Referenced to 25°C				0.54		V/°C		
I _{DSS}	Zero Gat	Zero Gate Voltage Drain Current		V _{DS} = 400 V, V _{GS} = 0 V						1	μA
				320 V, T _C =					10	μA	
GSSF		dy Leakage Current,		$V_{GS} = 30 V, V_{DS} = 0 V$ $V_{GS} = -30 V, V_{DS} = 0 V$						100	nA
GSSR	Gate-Bo	dy Leakage Current,	Reverse							-100	nA
on Cha	racteris	tico									
		reshold Voltage	_	$\lambda = -\lambda$	/ _{GS} , I _D = 2	50 4		2.0		4.0	V
/ _{GS(th)}		ain-Source	_				-	2.0		4.0	v
R _{DS(on)}	On-Resis	stance	_		10 V, I _D = 5			-	0.5	0.53	Ω
ĴFS	Forward	Transconductance	_	$v_{DS} = 4$	10 V, I _D = 5	.25 A			7.1		S
Jvnami	ic Chara	acteristics									
C _{iss}	1	pacitance	_	<u>)</u>		0.14			840	1090	pF
Coss	-	apacitance	_	$V_{DS} = 2$ f = 1.0	25 V, V _{GS} =	= 0 V,			250	325	pF
C _{rss}		Transfer Capacitance	۵	1 = 1.01	IVINZ				85	110	pF
-155	11010100		•						00		Pi
Switchi	ng Chai	racteristics									
d(on)	Turn-On	Delay Time			200 V, I _D =	10 5 A			14	40	ns
r	Turn-On	Rise Time		$R_{G} = 2$	-	10.0 Å,			89	190	ns
d(off)	Turn-Off	Delay Time		- ···G =·					81	170	ns
f	Turn-Off	Fall Time					(Note 4)	-	81	170	ns
ζ _g	Total Ga	te Charge		V _{DS} = 3	320 V, I _D =	10.5 A,		-	28	35	nC
Ω _{gs}	Gate-So	urce Charge		$V_{GS} = 2$	2	,		-	4		nC
2 _{gd}	Gate-Dra	ain Charge					(Note 4)	-	15		nC
										I.	
Drain-S	ource D	iode Characteri	istics ar	nd Max	imum R	atings			1		<u> </u>
s	Maximur	n Continuous Drain-S	Source Dic	ode Forwa	ard Curren	t				10.5	A
	Maximur	n Pulsed Drain-Sourc	ce Diode F							42	A
	Drain-So	ource Diode Forward	Voltage		-					1.4	V
	Reverse	Recovery Time			-				290		ns
n Qm	Dovorco	Recovery Charge		dl _F / dt	= 100 A/µs	i		-	2.4		μC
I _S I _{SM} V _{SD}	Maximur Maximur Drain-So Reverse	n Continuous Drain-S n Pulsed Drain-Sourc purce Diode Forward Recovery Time	Source Dic ce Diode F	Forward C $V_{GS} = 0$ $V_{GS} = 0$	ard Curren	0.5 A 0.5 A,			 290	42 1.4 	Ê

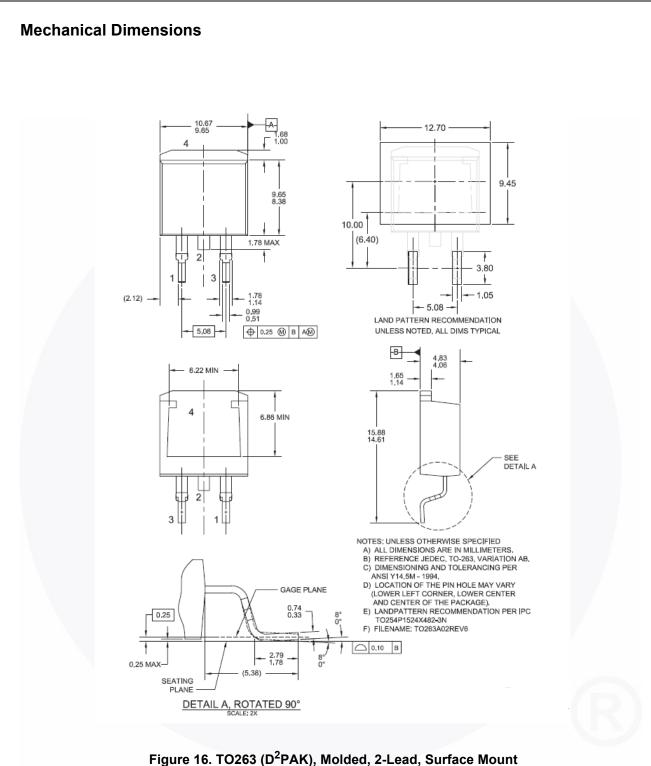
FQB11N40C — N-Channel QFET[®] MOSFET











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FQB11N40C — N-Channel QFET[®] MOSFET



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